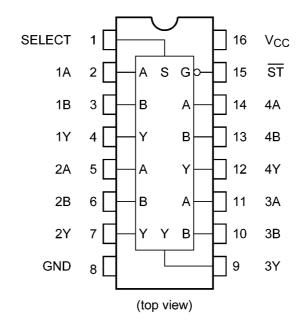
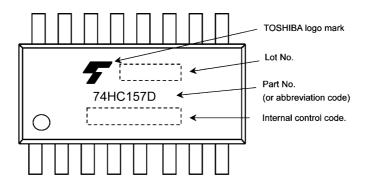


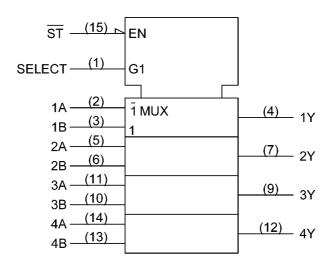
5. Pin Assignment



6. Marking



7. IEC Logic Symbol



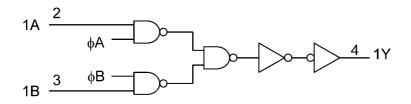


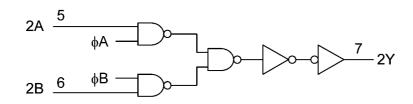
8. Truth Table

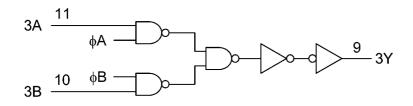
ST	SELECT	Α	В	OUTPUT
Н	Х	Х	Х	L
L	L	L	Х	L
L	L	Н	Х	Н
L	Н	Х	L	L
L	Н	Х	Н	Н

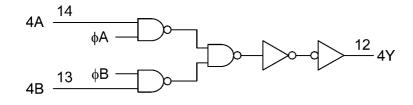
X: Don't care

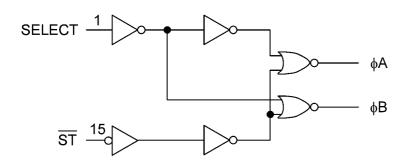
9. System Diagram













10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to V _{CC} + 0.5	V
Output voltage	V _{out}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		±20	mA
Output diode current	lok		±20	mA
Output current	l _{out}		±25	mA
V _{CC} /ground current	I _{CC}		±50	mA
Power dissipation	P_D	(Note 1)	500	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: PD derates linearly with -8 mW/°C above 85 °C

11. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Note	Rating	Unit
Supply voltage	V _{CC}	_		2.0 to 6.0	V
Input voltage	V _{IN}	_		0 to V _{CC}	V
Output voltage	V _{OUT}	_		0 to V _{CC}	V
Operating temperature	T _{opr}	_	(Note 1)	-40 to 125	°C
Input rise and fall times	t _r ,t _f	V _{CC} = 2.0 V		0 to 1000	ns
		V _{CC} = 4.5 V		0 to 500	
		V _{CC} = 6.0 V		0 to 400	

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs and bus inputs must be tied to either V_{CC} or GND.

Note 1: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.



12. Electrical Characteristics

12.1. DC Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	_	V
				4.5	3.15	_	_	
				6.0	4.20	_	_	
Low-level input voltage	V _{IL}	_		2.0		_	0.50	V
				4.5		_	1.35	
				6.0	_	_	1.80	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -20 μA	2.0	1.9	2.0	_	V
				4.5	4.4	4.5	_	
				6.0	5.9	6.0	_	
			I _{OH} = -4 mA	4.5	4.18	4.31	_	
			I _{OH} = -5.2 mA	6.0	5.68	5.80	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 20 μA	2.0	_	0.0	0.1	V
				4.5	_	0.0	0.1	
				6.0	_	0.0	0.1	
			I _{OL} = 4 mA	4.5	_	0.17	0.26	
			I _{OL} = 5.2 mA	6.0		0.18	0.26	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0	_	_	±0.1	μА
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		6.0	_	_	4.0	μΑ

12.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				4.5	3.15	_]
				6.0	4.20	-	
Low-level input voltage	V _{IL}	_		2.0	_	0.50	\ \
				4.5		1.35	
				6.0		1.80	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -20 μA	2.0	1.9	_	V
				4.5	4.4	_	
				6.0	5.9	_	
			I_{OH} = -4 mA	4.5	4.13		
			I _{OH} = -5.2 mA	6.0	5.63	_	
Low-level output voltage	V _{OL}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OL} = 20 μA	2.0		0.1	\ \
				4.5	_	0.1	
				6.0	ı	0.1	
			I _{OL} = 4 mA	4.5		0.33	
			I _{OL} = 5.2 mA	6.0	_	0.33	
Input leakage current	I _{IN}	$V_{IN} = V_{CC}$ or GND		6.0		±1.0	μА
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		6.0	_	40.0	μА



12.3. DC Characteristics (Note) (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Test Condition	Test Condition		Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				4.5	3.15	_	
				6.0	4.20	_	
Low-level input voltage	V _{IL}	_		2.0	ı	0.50	\ \
				4.5		1.35	
				6.0	_	1.80	
High-level output voltage	V _{OH}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OH} = -20 μA	2.0	1.9	_	V
				4.5	4.4	_	
				6.0	5.9	_	
			I _{OH} = -4 mA	4.5	3.7	_	
			I _{OH} = -5.2 mA	6.0	5.2	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 20 μA	2.0	_	0.1	V
				4.5	_	0.1	
				6.0	_	0.1	
			I _{OL} = 4 mA	4.5	_	0.4	
			I _{OL} = 5.2 mA	6.0	_	0.4	
Input leakage current	I _{IN}	$V_{IN} = V_{CC}$ or GND		6.0	_	±1.0	μА
Quiescent supply current	Icc	$V_{IN} = V_{CC}$ or GND		6.0	_	80.0	μА

Note: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.

12.4. AC Characteristics (Unless otherwise specified, C_L = 15 pF, V_{CC} = 5 V, T_a = 25 °C, Input: t_r = t_f = 6 ns)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	t _{TLH} ,t _{THL}	_	_	4	8	ns
Propagation delay time (A, B - Y)	t _{PLH} ,t _{PHL}	_	_	10	16	ns
Propagation delay time (SELECT - Y)	t _{PLH} ,t _{PHL}	_	_	13	21	ns
Propagation delay time (\overline{ST} - Y)	t _{PLH} ,t _{PHL}	_	_	10	19	ns



12.5. AC Characteristics (Unless otherwise specified, $C_L = 50$ pF, $T_a = 25$ °C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Note	V _{CC} (V)	Min	Тур.	Max	Unit
Output transition time	t _{TLH} ,t _{THL}		2.0	_	30	75	ns
			4.5	_	8	15	
			6.0	_	7	13	
Propagation delay time (A, B - Y)	t _{PLH} ,t _{PHL}		2.0	_	36	100	ns
			4.5	_	12	20	
			6.0	_	10	17	
Propagation delay time (SELECT - Y)	t _{PLH} ,t _{PHL}		2.0	_	50	125	ns
			4.5	_	16	25	
			6.0	_	14	21	
Propagation delay time (ST - Y)	t _{PLH} ,t _{PHL}		2.0	_	36	115	ns
			4.5	_	12	23	
			6.0	_	10	20	
Input capacitance	C _{IN}		_	_	5	_	pF
Power dissipation capacitance	C _{PD}	(Note 1)	_	_	57	_	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{|N} + I_{CC}/4 \text{ (per bit)}$

12.6. AC Characteristics (Unless otherwise specified, $C_L = 50$ pF, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	V _{CC} (V)	Min	Max	Unit
Output transition time	t _{TLH} ,t _{THL}	2.0	_	95	ns
		4.5	_	19	
		6.0	_	16	
Propagation delay time (A, B - Y)	t _{PLH} ,t _{PHL}	2.0	_	125	ns
		4.5	_	25	
		6.0	_	21	
Propagation delay time (SELECT - Y)	t _{PLH} ,t _{PHL}	2.0	_	155	ns
		4.5	_	31]
		6.0	_	26	
Propagation delay time (ST - Y)	t _{PLH} ,t _{PHL}	2.0	_	145	ns
		4.5	_	29]
		6.0	_	25	



12.7. AC Characteristics (Note) (Unless otherwise specified, $C_L = 50$ pF, $T_a = -40$ to 125 °C, Input: $t_r = t_f = 6$ ns)

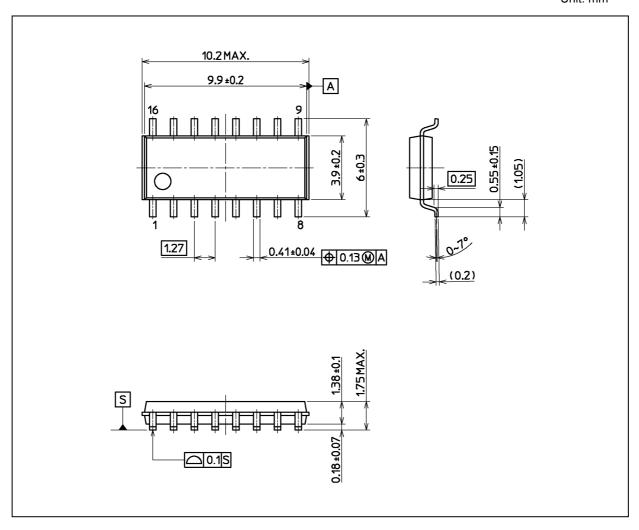
Characteristics	Symbol	V _{CC} (V)	Min	Max	Unit
Output transition time	t _{TLH} ,t _{THL}	2.0	_	110	ns
		4.5	_	22	
		6.0	_	18]
Propagation delay time (A, B - Y)	t _{PLH} ,t _{PHL}	2.0	_	145	ns
		4.5	_	29	
		6.0	_	24]
Propagation delay time (SELECT - Y)	t _{PLH} ,t _{PHL}	2.0	_	175	ns
		4.5	_	35	
		6.0	_	30]
Propagation delay time (ST - Y)	t _{PLH} ,t _{PHL}	2.0	_	165	ns
		4.5	_	33]
		6.0	_	29	1

Note: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.



Package Dimensions

Unit: mm



Weight: 0.15 g (typ.)

	Package Name(s)
Nickname: SOIC16	

Rev.4.0



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